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TEST REPORT

Applicant : SPECTOR & CO

Address : 5700 KIERAN ROAD, ST. LAURENT, QUEBEC, Canada H4S 2B5

Sample Description

Type of Product : Bluetooth speaker

Brand : /

Model No. of Product : T270

Date of Received : Sep. 24, 2014

Date of test Conducted : Nov. 3, 2014 - Nov. 7, 2014

Test

Test Method : UL/CSA 60065 Clause 14.10.4, Clause 14.10.5, Clause 11.2

Sample quantity : 2

Test Observation: : See pages 2-5 for details.

Remark : When determine the test result, measurement uncertainty has been

considered.

***********	End of page	***********
Tested By		Approved by:

Signed on file

0: 0

Simon Sun Wisons Lin

Project Engineer Project Engineer

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Clause	Requirement + Test Result - Remark		Verdict	
11	Fault conditions			
11.1	No shock hazard under fault condition		Р	
11.2	Heating under fault condition		Р	
	Flames extinguish within 10 seconds	No flame during testing	N/A	
	No hazard from softening solder	No softening solder	N/A	
	Soldered terminations not used as protective mechanism		Р	
11.2.1	Measurement of temperature rises (see appended table 11.2)			
11.2.2	Temperature rise of accessible parts (see appended table 11.2)			
11.2.3	Temperature rise of parts, other than windings and printed boards, providing electrical insulation		N/A	
11.2.4	Temperature rise of parts acting as a support or mechanical barrier No such parts		N/A	
11.2.5	Temperature rise of windings	(see appended table 11.2)	Р	
11.2.6	Temperature rise of printed boards shall not exceed the limits of table 3 by max. 100 K for max. 5 min	(see appended table 11.2)	Р	
	Printed circuit boards (PCB) classified as V-0 according to 60695-11-10 or Clause G.1 may exceed the limit in table 3 in case a) and b):		N/A	
	a) Temperature rise of printed circuit boards exceeding the limits of table 3 by not more than 100 K for an area not greater than 2 cm ² :		N/A	
	b) Temperature rise of printed circuit boards exceeding the limits of table 3 up to 300 K for an area not greater than 2 cm² for a maximum of 5 min		N/A	
	Meets all the special conditions if conductors on printed circuit boards are interrupted		N/A	
	Class I protective earthing maintained		N/A	
11.2.7	Temperature rise of parts not subject to the limits of 11.2.1 to 11.2.6 shall not exceed the limits in table 3, item e), "Fault conditions".		N/A	
14	Components		Р	
14.10.4	Battery mould stress relief		Р	
14.10.5	Battery drop test		Р	



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Claus	se	Requirement + Test Result - Remark		- Remark	Verdict		
11.2		TABL	.E: sum	mary of fault condition tests			Р
		ge (V) 0,			5V DC		
	3 (, , .		ency (H	z):			_
				erature (°C):	: 24 °C – 35 °C		_
No.	Com	•		dT (K) / Component		Other results (include description and test duration)	
1.	Batte outpu			The apparatus was protected immediately and the input current dropped to 0A, no hazardous phenomena			
2.	Spea	eaker SC 20/PCB surface(near SS14) 14/PCB surface(near IC1) 14/PCB surface(near IC2) 14/PCB surface(near IC3) 20/PCB surface(near IC4) 15/PCB surface(near IC5) 12/Battery surface 10/Internal enclosure surface(non-metallic) 9/External enclosure surface(non-metallic)		Un(V) = 5,5; Pn(W) = 3,98; In(mA) = 723 Result: No hazards.			
3.	Batte	ery	Overc harge	19/PCB surface(near SS14) 12/PCB surface(near IC1) 13/PCB surface(near IC2) 12/PCB surface(near IC3) 12/PCB surface(near IC4) 12/PCB surface(near IC5) 11/Battery surface 9/Internal enclosure surface(non metallic) 9/External enclosure surface(non metallic)		Un(V) = 5,5; Pn(W) = In(mA) = 483 Result: No hazards. No temperature rise exceeding its limit occ	

1. Max=max non-clipped or available output power, SC=short circuit, OL=over load, BL=block.



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Clause Requirement + Test Result - Remark Verdict

Photo:

